5A, 50V - 1000V Surface Mount Rectifier

FEATURES

TAIWAN

Glass passivated chip junction

EMICONDUCTOR

- Ideal for automated placement
- Low forward voltage drop
- High current capability
- High surge current capability
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- Converter

MECHANICAL DATA

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Part no. with suffix "H" means AEC-Q101 qualified
- Packing code with suffix "G" means green compound (halogen-free)
- Moisture sensitivity level: level 1, per J-STD-020
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.21 g (approximately)

KET PARAMETERS				
PARAMETER	VALUE	UNIT		
I _{F(AV)}	5	А		
V _{RRM}	50 - 1000	V		
I _{FSM}	100	А		
T _{J MAX}	150	°C		
Package	DO-214AB	(SMC)		
Configuration	Single die			

VEV DADAMETEDO





DO-214AB (SMC)

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)									
PARAMETER	SYMBOL	S5A	S5B	S5D	S5G	S5J	S5K	S5M	UNIT
Marking code on the device		S5A	S5B	S5D	S5G	S5J	S5K	S5M	
Repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	V _{R(RMS)}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	V
Forward current	I _{F(AV)}				5				А
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	I _{FSM}				100				A
Junction temperature	TJ			- 5	55 to +1	50			°C
Storage temperature	T _{STG}			- 5	55 to +1	50			°C



THERMAL PERFORMANCE				
PARAMETER	SYMBOL	ТҮР	UNIT	
Junction-to-lead thermal resistance per diode	R _{ejl}	13	°C/W	
Junction-to-ambient thermal resistance per diode	R _{eja}	47	°C/W	

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP.	MAX.	UNIT
Forward voltage per diode (1)	I _F = 5A, T _J = 25°C	V _F	-	1.15	V
Reverse current @ rated V_R per diode $^{(2)}$	T _J = 25°C		-	10	μA
	T _J = 125°C	I _R	-	250	μA
Junction capacitance	1 MHz, V _R =4.0V	CJ	60	-	pF
Reverse recovery time	I _F =0.5A , I _R =1.0A I _{RR} =0.25A	+	1500	-	ns
	I _{RR} =0.25A	t _{rr}			

Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms

ORDERING INFORMATION					
PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING
		R7	G	SMC	850 / 7" Plastic reel
		R6		SMC	3,000 / 13" Paper reel
S5x (Note 1,2)	Н	M6		SMC	3,000 / 13" Plastic reel
(100001,2)		V7		Matrix SMC	850 / 7" Plastic reel
		V6		Matrix SMC	3,000 / 13" Plastic reel

Note :

1. "x" defines voltage from 50V (S5A) to 1000V (S5M)

2. Only V6 and V7 are all green compound (halogen free)

EXAMPLE					
EXAMPLE P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
S5AHR7G	S5A	Н	R7	G	AEC-Q101 qualified Green compound



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

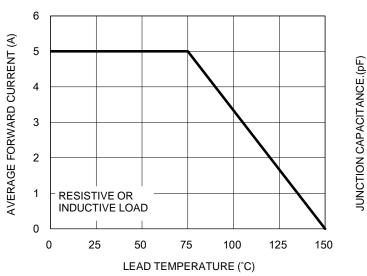


Fig.1 Forward Current Derating Curve

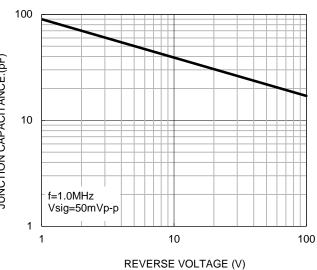


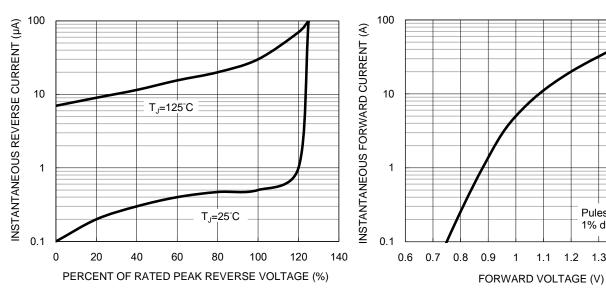
Fig.2 Typical Junction Capacitance

Fig.3 Typical Reverse Characteristics



1.1

1.2



Pules width=300µs

1.4

1.5 1.6

1% duty cycle

1.3



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.5 Maximum Non-repetitive Forward Surge Current

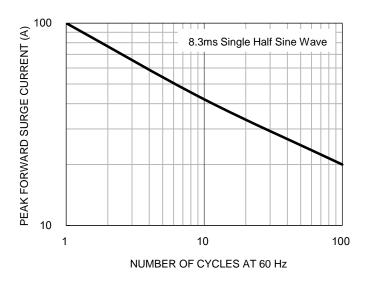
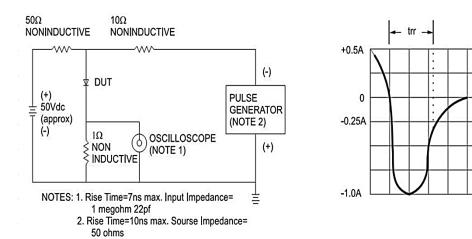


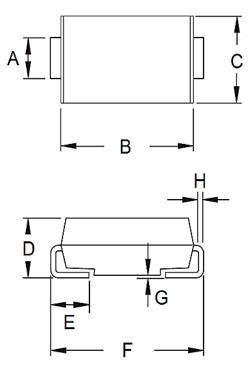
Fig.6 Reverse Recovery Time Characteristic And Test Circuit Diagram





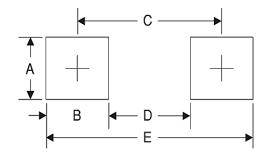
PACKAGE OUTLINE DIMENSIONS

DO-214AB (SMC)



DIM. Unit		(mm)	Unit	(inch)
DIN.	Min.	/lin. Max.		Max.
А	2.90	3.20	0.114	0.126
В	6.60	7.11	0.260	0.280
С	5.59	6.22	0.220	0.245
D	2.00	2.62	0.079	0.103
E	1.00	1.60	0.039	0.063
F	7.75	8.13	0.305	0.320
G	0.10	0.20	0.004	0.008
Н	0.15	0.31	0.006	0.012

SUGGESTED PAD LAYOUT

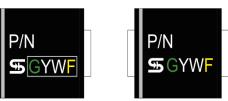


Symbol	Unit (mm)	Unit (inch)
А	3.30	0.130
В	2.50	0.098
С	6.80	0.268
D	4.40	0.173
E	9.40	0.370

MARKING DIAGRAM

Matrix SMC





P/N =	Marking Code
-------	--------------

- G =Green Compound
- YW =Date Code
- F =Factory Code



Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.